

# **LIST OF REFERENCES CITED BY APPLICANT**

(Use several sheets if necessary)

**Atty. Docket No.**  
YOR920020293US1 (16348)

**Serial No.**  
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**Applicant**  
Gareth G. Hougham, et al.

**Filing Date**  
April 15, 2005

**Group**  
2833

## **U.S. PATENT DOCUMENTS**

EXAMINER INITIAL*		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE (if appropriate)
	AA	4,813,129 A	03/21/1989	Karnezos			
	AB	5,599,193 A	02/04/1997	Crotzer			
	AC	5,624,268 A	04/29/1997	Maeda, et al.			
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	AI						

		Foreign Document Number	Date	Country	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
		WO 01/89038 A2	November 22, 2001	PCT			X	

## **OTHER PRIOR ART (Including Author, Title, Date, Pertinent Pages, Etc.)**

		"Metallized Elastomeric Bumps for Chip and Zero Insertion Force Connectors", IBM Technical Disclosure Bulletin, IBM Corp., New York, Vol. 37, No. 9; September 1, 1994, Page 625 (XP 000475526)

**EXAMINER**

**DATE CONSIDERED**

\* EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.